

## 74ALVC32

### Low Voltage Quad 2-Input OR Gate with 3.6V Tolerant Inputs and Outputs

#### General Description

The ALVC32 contains four 2-input OR gates. This product is designed for low voltage (1.65V to 3.6V)  $V_{CC}$  applications with I/O compatibility up to 3.6V.

The ALVC32 is fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

#### Features

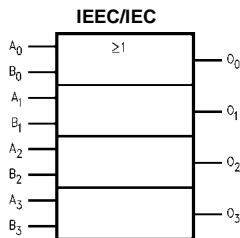
- 1.65V to 3.6V  $V_{CC}$  supply operation
- 3.6V tolerant inputs and outputs
- $t_{PD}$ 
  - 2.8 ns max for 3.0V to 3.6V  $V_{CC}$
  - 3.1 ns max for 2.3V to 2.7V  $V_{CC}$
  - 4.7 ns max for 1.65V to 1.95V  $V_{CC}$
- Power-off high impedance inputs and outputs
- Uses patented Quiet Series™ noise/EMI reduction circuitry
- Latchup conforms to JEDEC JED78
- ESD performance:
  - Human body model > 2000V
  - Machine model > 250V

#### Ordering Code:

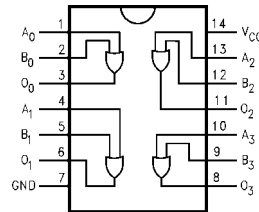
Order Number	Package Number	Package Description
74ALVC32M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74ALVC32MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### Logic Symbol



#### Connection Diagram



#### Pin Descriptions

Pin Names	Description
$A_n, B_n$	Inputs
$O_n$	Outputs

Quiet Series™ is a trademark of Fairchild Semiconductor Corporation.

**Absolute Maximum Ratings** (Note 1)

Supply Voltage ( $V_{CC}$ )	-0.5V to +4.6V
DC Input Voltage ( $V_I$ )	-0.5V to 4.6V
Output Voltage ( $V_O$ ) (Note 2)	-0.5V to $V_{CC} + 0.5V$
DC Input Diode Current ( $I_{IK}$ )	
$V_I < 0V$	-50 mA
DC Output Diode Current ( $I_{OK}$ )	
$V_O < 0V$	-50 mA
DC Output Source/Sink Current ( $I_{OH}/I_{OL}$ )	±50 mA
DC $V_{CC}$ or GND Current per Supply Pin ( $I_{CC}$ or GND)	±100 mA
Storage Temperature Range ( $T_{STG}$ )	-65°C to +150°C

**Recommended Operating Conditions** (Note 3)

Power Supply	
Operating	1.65V to 3.6V
Input Voltage ( $V_I$ )	0V to $V_{CC}$
Output Voltage ( $V_O$ )	0V to $V_{CC}$
Free Air Operating Temperature ( $T_A$ )	-40°C to +85°C
Minimum Input Edge Rate ( $\Delta t/\Delta V$ )	
$V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	5 ns/V

**Note 1:** The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Note 2:**  $I_O$  Absolute Maximum Rating must be observed, limited to 4.6V.

**Note 3:** Floating or unused control inputs must be held HIGH or LOW.

**DC Electrical Characteristics**

Symbol	Parameter	Conditions	$V_{CC}$ (V)	Min	Max	Units
$V_{IH}$	HIGH Level Input Voltage		1.65 - 1.95	$0.65 \times V_{CC}$		V
			2.3 - 2.7	1.7		
			2.7 - 3.6	2.0		
$V_{IL}$	LOW Level Input Voltage		1.65 - 1.95		$0.35 \times V_{CC}$	V
			2.3 - 2.7		0.7	
			2.7 - 3.6		0.8	
$V_{OH}$	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	1.65 - 3.6	$V_{CC} - 0.2$		V
		$I_{OH} = -4 \text{ mA}$	1.65	1.2		
		$I_{OH} = -6 \text{ mA}$	2.3	2.0		
		$I_{OH} = -12 \text{ mA}$	2.3	1.7		
			2.7	2.2		
			3.0	2.4		
$V_{OL}$	LOW Level Output Voltage	$I_{OL} = 100 \mu A$	1.65 - 3.6		0.2	V
		$I_{OL} = 4 \text{ mA}$	1.65		0.45	
		$I_{OL} = 6 \text{ mA}$	2.3		0.4	
		$I_{OL} = 12 \text{ mA}$	2.3		0.7	
			2.7		0.4	
			3.0		0.55	
$I_I$	Input Leakage Current	$0 \leq V_I \leq 3.6V$	3.6		±5.0	μA
$I_{CC}$	Quiescent Supply Current	$V_I = V_{CC}$ or GND, $I_O = 0$	3.6		10	μA
$\Delta I_{CC}$	Increase in $I_{CC}$ per Input	$V_{IH} = V_{CC} - 0.6V$	3 - 3.6		750	μA

## AC Electrical Characteristics

Symbol	Parameter	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}, R_L = 500\Omega$								Units
		$C_L = 50\text{ pF}$				$C_L = 30\text{ pF}$				
		$V_{CC} = 3.3\text{V} \pm 0.3\text{V}$		$V_{CC} = 2.7\text{V}$		$V_{CC} = 2.5\text{V} \pm 0.2\text{V}$		$V_{CC} = 1.8\text{V} \pm 0.15\text{V}$		
		Min	Max	Min	Max	Min	Max	Min	Max	
$t_{PHL}, t_{PLH}$	Propagation Delay	1.0	2.8		2.9	1.0	3.1	1.0	4.7	ns

## Capacitance

Symbol	Parameter	Conditions	$T_A = +25^{\circ}\text{C}$		Units
			$V_{CC}$	Typical	
$C_{IN}$	Input Capacitance	$V_I = 0\text{V or } V_{CC}$	3.3	4	pF
$C_{PD}$	Power Dissipation Capacitance	$f = 10\text{ MHz}, C_L = 50\text{ pF}$	3.3	26	pF
			2.5	24	
			1.8	23	

## AC Loading and Waveforms

TABLE 1. Values for Figure 1

TEST	SWITCH
$t_{PLH}, t_{PHL}$	Open

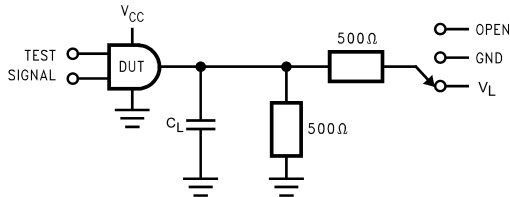


FIGURE 1. AC Test Circuit

TABLE 2. Variable Matrix  
(Input Characteristics:  $f = 1\text{MHz}; t_r = t_f = 2\text{ns}; Z_0 = 50\Omega$ )

Symbol	$V_{CC}$			
	$3.3\text{V} \pm 0.3\text{V}$	$2.7\text{V}$	$2.5\text{V} \pm 0.2\text{V}$	$1.8\text{V} \pm 0.15\text{V}$
$V_{mi}$	1.5V	1.5V	$V_{CC}/2$	$V_{CC}/2$
$V_{mo}$	1.5V	1.5V	$V_{CC}/2$	$V_{CC}/2$

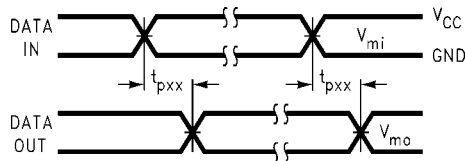
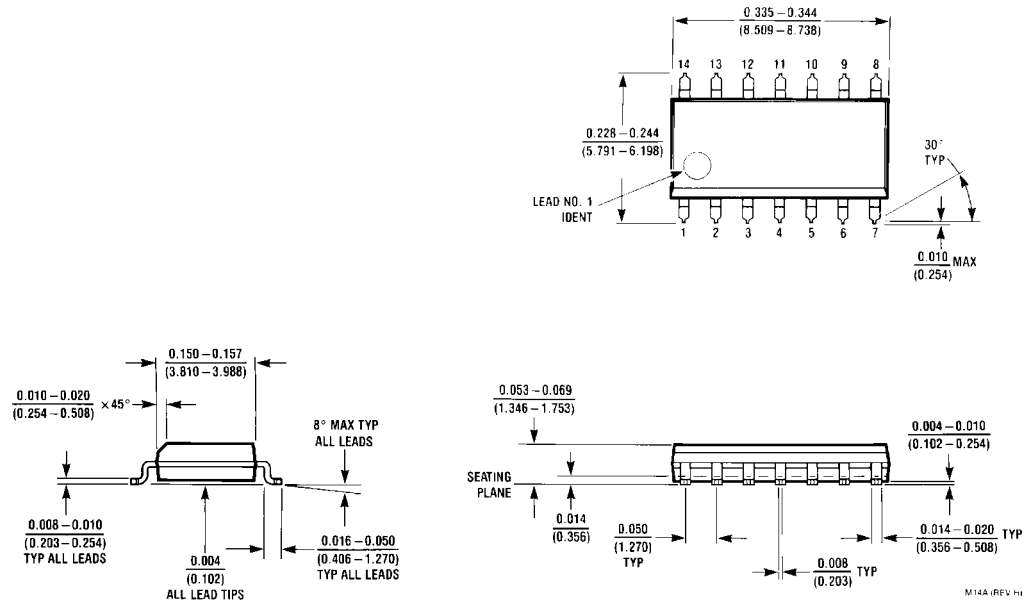


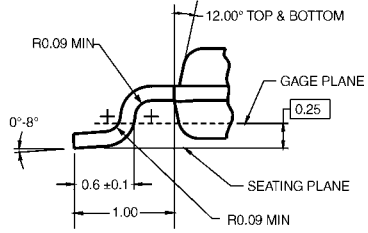
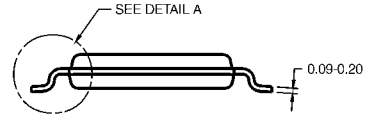
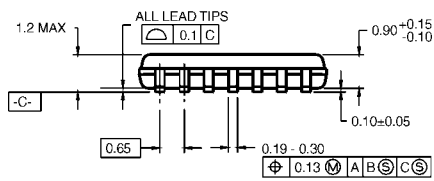
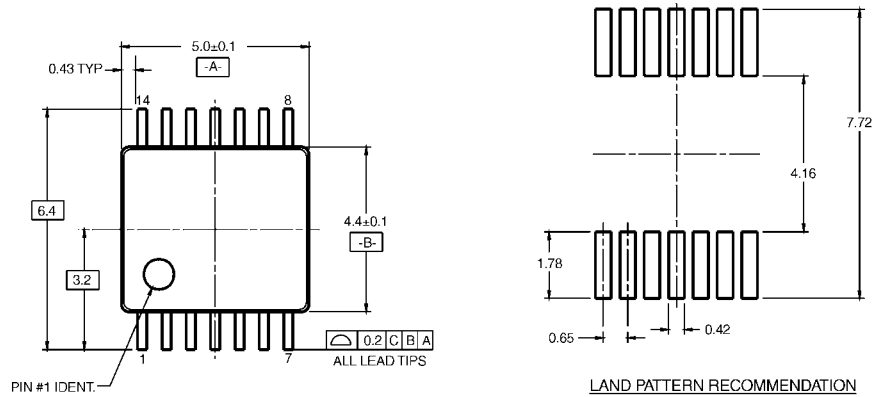
FIGURE 2. Waveform for Inverting and Non-inverting Functions

**Physical Dimensions** inches (millimeters) unless otherwise noted



**14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M14A**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



- NOTES:  
 A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATE 7/93.  
 B. DIMENSIONS ARE IN MILLIMETERS.  
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.  
 D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC14RevC3

**14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14**

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